







## DISCRIPTION

## **FEATURES**

Ferrite
High frequency design
Excellent Q values
Excellent SRF
High reliability
Excellent thermal stability

## **OPTIONS**

Tape & Reel is Standard (Qty: 3.000 Pcs)
Bulk Packing Available for smaller quantites
Tolerance: J = 5% and K=10% is Standard,
tighter Tolerance available (MOQ on request)

## **APPLICATIONS**

Modems
Mobile Radios
Cordless Telephones
Global Positioning Systems
Telecommunications Systems

## PHYSICAL CHARACTERISTICS

Testing: (Equivalents acceptable) Inductance & Q-HP4191A + HP4291A

SRF: HP8553B; RDC: 25°C
• Operating Temperature: -55°C ~ 85°C

Pad metalization: Silver-nickel with 90/10 solder
Solder methods: Wave, Reflow, Vapor Phase
Solderability: Max 260°C for 10 seconds

• Marking : EIA color code

## **ELECTRICAL SPECIFICATIONS**

Properties	Test conditions		Value	Unit	Tol.
Inductance		L	330	μH	see Site 2
Q factor		Q	15		min.
DC-resistance		DCR typ.		Ω	typ.
DC-resistance		DCR max.	17,8	Ω	max.
Self-Res. Freq.		SRF	2,3	Mhz	min.
Test-Freq.			0,796	Mhz	
Rated Current		IDC	55	mA	max.
Saturation Current		Isat		mA	typ.

1. This electronic component is meant to be used in general electronic equipment. Before the incorporation SMT WIRE-WOUND of this component into any equipment with higher and more reliable requirements such as aviation, **CHIP INDUCTORS** aerospace, submarine, nuclear control, transportation, transportation signal, disaster prevention, medical, public information network, etc. or if there is a possibility of injuries or damages to the human body, Edcon -Components must be informed before the stage of design-in. Evaluation checks for safety have to be Part No.: S12008-331 performed on each electronic components used in electrical circuits that require high safety and reliability functions. Customer: DRW: Chang CHKD Young MATL: Chu Chi DATE 09.06.2009 APPD: **FINISH** Vienna 1 from 2 Pong Sheet



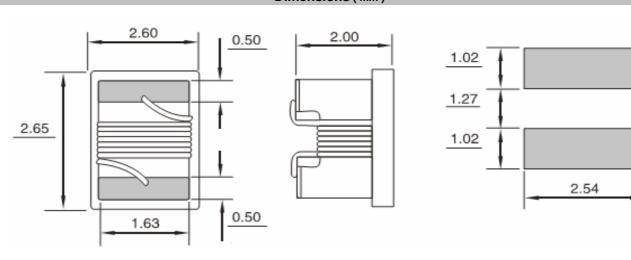






## **TECHNICAL INFORMATIONS**

## Dimensions ( mm )



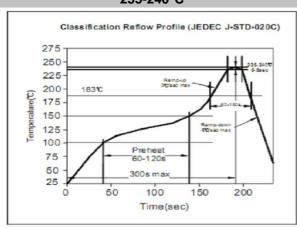
## **Ordering Information**

Serie and Range			
S12008-331			

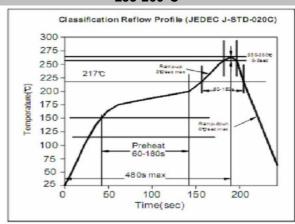
Tolerance	ROHS	Packing	
K	R	TR	

<b>J</b> = 5%	R = ROHS	<b>BU</b> = Bulk Ware
<b>K</b> = 10%	N = non ROHS	TR = Tape Reel
<b>M</b> = 20%		
<b>N</b> = 30%		

## Soldering Profile for Lead Free Soldering 235-240°C



## Soldering Profile for Lead Free Soldering 255-260°C



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functions.

# SMT WIRE-WOUND CHIP INDUCTORS

Part No.: **\$12008-331** 

Customer:

 DRW:
 Chang
 CHKD
 Young
 MATL:
 Chu Chi
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